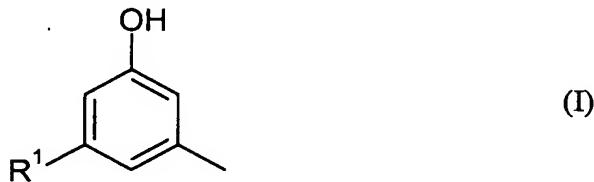


Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Original) A two-component epoxy resin composition, characterized in that it comprises in the hardener component at least one Mannich base and after curing at a temperature between 5°C and 60°C has a glass transition temperature of more than 80°C.
2. (Original) The two-component epoxy resin composition as claimed in claim 1, characterized in that the Mannich base is prepared using a phenolic compound of the formula (I) or (II)



with R¹ = H or CH₃,

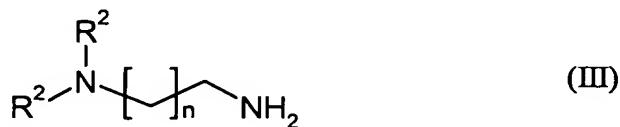
and also formaldehyde and at least one polyamine.

3. (Currently Amended) The two-component epoxy resin composition as claimed in claim 1 or claim 2, characterized in that the Mannich base is prepared using a phenolic compound of the formula (I) with R¹ = H.

4. (Currently Amended) The two-component epoxy resin composition as claimed in ~~any one of the preceding claims~~ claim 1, characterized in that, for the preparation of the Mannich base, in a first stage at least one phenolic compound of the formula (I) or (II) is reacted with

formaldehyde in the presence of a tertiary amine and in a subsequent stage reaction takes place with at least one polyamine.

5. (Original) The two-component epoxy resin composition as claimed in claim 4, characterized in that the tertiary amine has the formula (III)



with $\text{R}^2 = \text{C}_1\text{-C}_6$ alkyl and $n = 1, 2$, or 3 .

6. (Currently Amended) The two-component epoxy resin composition as claimed in ~~any one of the preceding claims~~claim 1, characterized in that the Mannich base contains not only secondary but also primary amino groups.

7. (Currently Amended) The two-component epoxy resin composition as claimed in ~~any one of the preceding claims~~claim 1, characterized in that the polyamines selected from the group encompassing DAMP, IPDA, 1,3- and 1,4-diaminocyclohexane, 1,2-diamino-cyclohexane 1,3- and 1,4-butanediamine, 1,3- and 1,5-pentanediamine, MPMD, 1,3-xylylenediamine, 1,3-bis(aminomethyl)cyclohexane, diethylenetriamine, triethylenetetramine (3,6-diaza-octamethylenediamine), tetraethylenepentamine, pentamethylenehexamine, dipropylenetriamine, tripropylenetetramine, tetrapropylenepentamine, 4,7-diaza-decamethylene-1,10-diamine, bis(4-aminocyclohexyl)methane, bis(4-amino-3-methyl-cyclohexyl)methane, 3(4),8(9)bis(aminomethyl)tricyclo[5.2.1.0^{2,6}]decane, and mixtures thereof.

8. (Currently Amended) The two-component epoxy resin composition as claimed in ~~any one of the preceding claims~~claim 1, characterized in that the polyamine is selected from the group encompassing 1,3-xylylenediamine, 1,3-bis(aminomethyl)cyclohexane, diethylene-triamine, triethylenetetramine (3,6-diazaoctamethylenediamine), tetraethylenepentamine,

IPDA, 1,2-diaminocyclohexane, 4,7-diaza-decamethylene-1,10-diamine, and mixtures thereof.

9. (Currently Amended) The two-component epoxy resin composition as claimed in ~~any one of the preceding claims~~claim 1, characterized in that curing takes place at a temperature between 10°C and 50°C, in particular between 10°C and 30°C.

10. (Currently Amended) The two-component epoxy resin composition as claimed in ~~any one of the preceding claims~~claim 1, characterized in that, after curing, the glass transition temperature is above 100°C, in particular between 100°C and 150°C.

11. (Currently Amended) The use of a two-component epoxy resin composition as claimed in ~~any one of claims 1 to 10~~claim 1 as an adhesive.

12. (Original) The use of a two-component epoxy resin composition as claimed in claim 11, characterized in that the adhesive is used for structural reinforcement.

13. (Original) The use of a two-component epoxy resin composition as claimed in claim 12, characterized in that the adhesive is used for bonding fiber-reinforced composites to built structures.

14. (Currently Amended) The use of a two-component epoxy resin composition as claimed in ~~any one of claims 1 to 10~~claim 1 as a polymeric matrix for producing fiber-reinforced composites.

15. (Currently Amended) A fiber-reinforced composite, characterized in that it is produced using a two-component epoxy resin composition as claimed in ~~any one of claims 1 to 10~~claim 1.

16. (Currently Amended) A method of adhesive bonding, characterized in that a two-component epoxy resin composition as claimed in ~~any one of claims 1 to 10~~claim 1 is mounted to at least one solid's surface and subsequently contacted with at least one further solid's surface.

17. (Currently Amended) A cured product obtained from a two-component epoxy resin composition as claimed in ~~any one of claims 1 to 10~~claim 1.